

Vishay Siliconix

## **Dual N-Channel 30-V (D-S) MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
30	0.040 at V <sub>GS</sub> = 10 V	5.8	2.8 nC			
30	$0.050 \text{ at V}_{GS} = 4.5 \text{ V}$	5.5	2.6110			

#### **FEATURES**

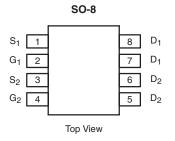
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET

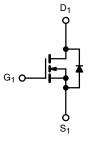
# Pb-free RoHS COMPLIANT HALOGEN

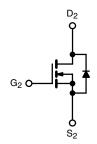
FREE

#### **APPLICATIONS**

- Low Current DC/DC Conversion
- Notebook System Power







Ordering Information: Si4936CDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATIN</b>	<b>GS</b> T <sub>A</sub> = 25 °C,	unless othe	rwise noted	
Parameter		Symbol Limit		Unit
Drain-Source Voltage		$V_{DS}$	30	V
Gate-Source Voltage		$V_{GS}$	± 20	V
	T <sub>C</sub> = 25 °C		5.8	
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	I <sub>D</sub>	4.6	
Continuous Diain Current (1) = 150 C)	T <sub>A</sub> = 25 °C		5.0 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C		4.0 <sup>a, b</sup>	Α
Pulsed Drain Current		I <sub>DM</sub>	20	
Continuous Course Dunin Dinda Current	T <sub>C</sub> = 25 °C		1.9	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	1.4 <sup>a, b</sup>	
	T <sub>C</sub> = 25 °C		2.3	
Maniana Danas Dissination	T <sub>C</sub> = 70 °C	1 .	1.5	14/
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.7 <sup>a, b</sup>	W
	T <sub>A</sub> = 70 °C	1	1.1 <sup>a, b</sup>	
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	58	75	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	42	55	O/ <b>V V</b>		

#### Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 110 °C/W.
- d. Based on  $T_C$  = 25 °C.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			<u> </u>	7.	<u> </u>	<u> </u>	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 v.A		32		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 5			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1.2		3	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	15			Α	
	` '	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5 A		0.033	0.040		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 4.7 A		0.041	0.050	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 5 \text{ A}$	1	15		S	
Dynamic <sup>b</sup>					1		
Input Capacitance	C <sub>iss</sub>			325			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		60		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			30			
Total Gate Charge		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		6	9	nC	
	Qg			2.8	4.2		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		1.1			
Gate-Drain Charge	$Q_{gd}$			0.8			
Gate Resistance	$R_g$	f = 1 MHz	0.6	2.8	5.6	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			12	18		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 3.8 $\Omega$		13	20	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong 4$ A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		16	25		
Fall Time	t <sub>f</sub>			11	17		
Turn-On Delay Time	t <sub>d(on)</sub>			4	8		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 3.8 $\Omega$		9	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 4 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		11	20		
Fall Time	t <sub>f</sub>			8	15		
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			1.9	А	
Pulse Diode Forward Current	I <sub>SM</sub>				20	^	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 4 A, V <sub>GS</sub> = 0 V		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			11	20	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 4 A, dI/dt = 100 A/μs, T <sub>J</sub> = 25 °C		4	8	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$_{1F} - 4 \text{ A}$ , $_{11} = 100 \text{ A/}\mu\text{s}$ , $_{13} = 25 \text{ C}$		6			
Reverse Recovery Rise Time	t <sub>b</sub>			5		ns	

#### Notes:

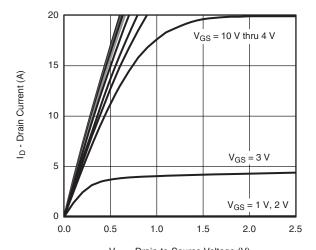
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

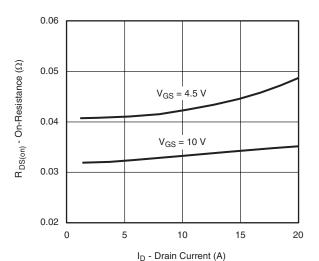


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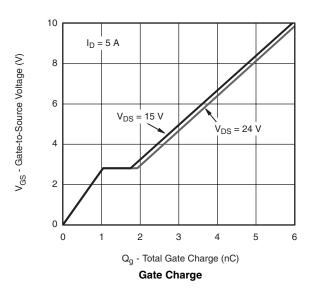
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



V<sub>DS</sub> - Drain-to-Source Voltage (V) **Output Characteristics** 

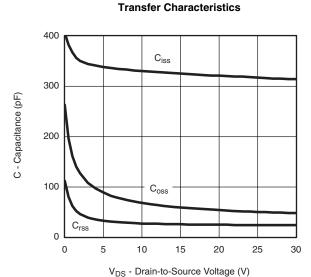


On-Resistance vs. Drain Current

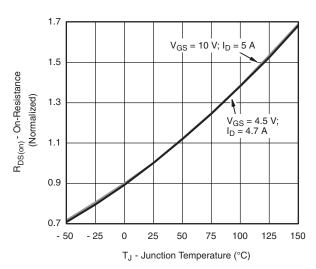


(v) to a sum of the control of the c

V<sub>GS</sub> - Gate-to-Source Voltage (V)



Capacitance

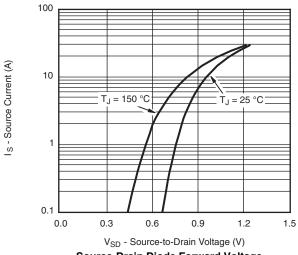


On-Resistance vs. Junction Temperature

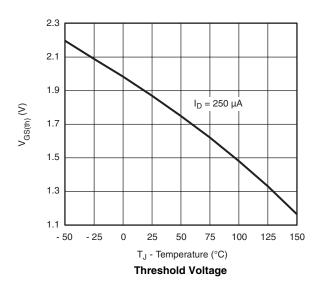
## Si4936CDY

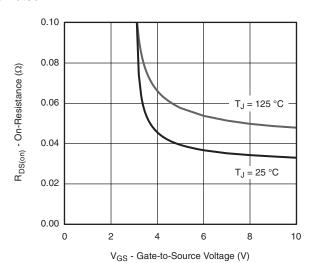
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

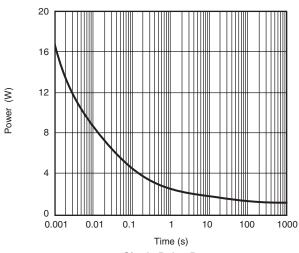


#### Source-Drain Diode Forward Voltage

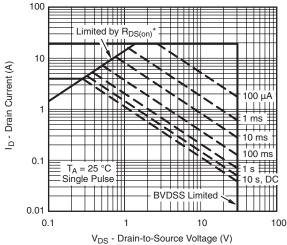




#### On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power

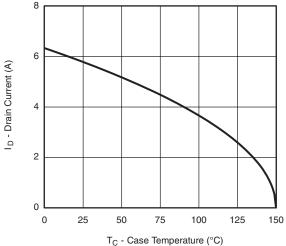


\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

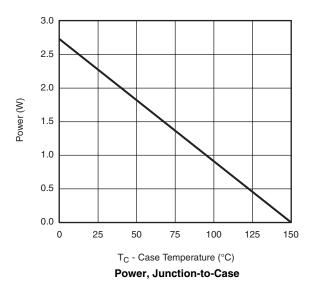
Safe Operating Area, Junction-to-Ambient

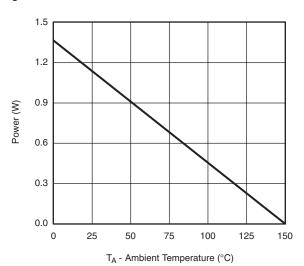
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### **Current Derating\***





Power, Junction-to-Ambient

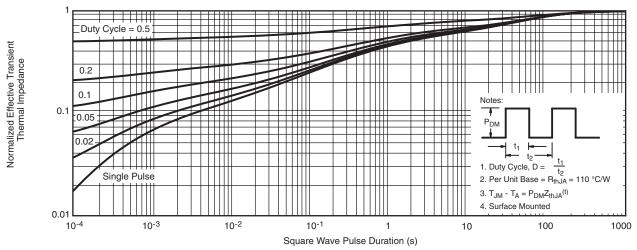
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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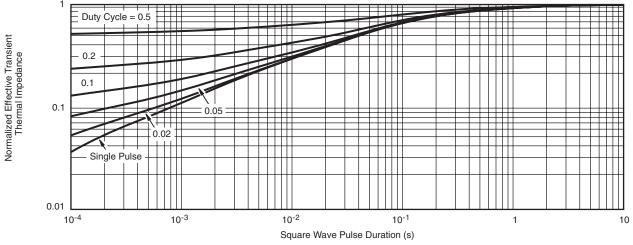
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?69097">www.vishay.com/ppg?69097</a>.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	INCHES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
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DWG: 5498

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#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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